

CMOS Digital Integrated Circuits Silicon Monolithic

# TC7SB3157DL6X

### 1. Functional Description

· Single 1-of-2 Multiplexer/Demultiplexer

#### 2. General

The TC7SB3157DL6X is a high-speed CMOS single 1-of-2 multiplexer/demultiplexer. The low ON resistance of the switch allows connections to be made with minimal propagation delay time.

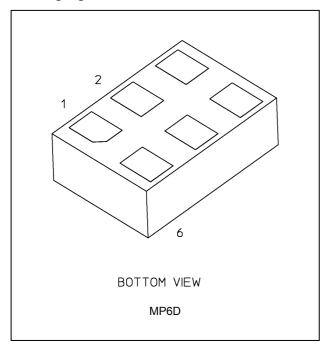
This device is 1 to 2 multiplexer/demultiplexer controlled by the select input (S). The A input is connected to B1 or B2 output based on the selection of Control input (S).

All inputs are equipped with protection circuits against static discharge.

#### 3. Features

- (1) Operating voltage:  $V_{CC} = 1.65$  to 5.5 V
- (2) ON capacitance:  $C_{I/O} = 15 \text{ pF Switch On (typ.)} @V_{CC} = 5.0 \text{ V}$
- (3) ON resistance:  $R_{\rm ON}$  = 4  $\Omega$  (typ.) @V\_{\rm CC} = 4.5 V,  $V_{\rm IS}$  = 0 V
- (4) Package: MP6D

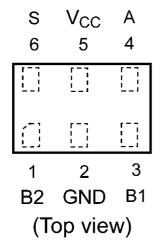
### 4. Packaging



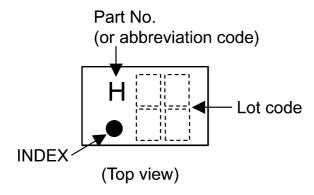
Start of commercial production



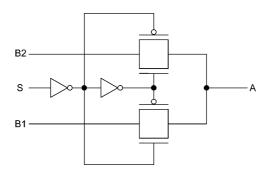
# 5. Pin Assignment



# 6. Marking



# 7. Block Diagram



Rev.3.0



### 8. Principle of Operation

#### 8.1. Truth Table

Inputs S	Function
L	A port = B1 port
Н	A port = B2 port

### 9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 6.5	V
Input voltage (S)	V <sub>IN</sub>		-0.5 to 6.5	
Switch I/O voltage	Vs		-0.5 to V <sub>CC</sub>	
Clamp diode current	I <sub>IK</sub>		-50	mA
Switch I/O current	I <sub>S</sub>		50	
Power dissipation	P <sub>D</sub>	(Note 1)	250	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>		±100	mA
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board

### 10. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		1.65 to 5.5	V
Input voltage(S)	V <sub>IN</sub>		0 to 5.5	
Switch I/O voltage	Vs		0 to V <sub>CC</sub>	
Operating temperature	T <sub>opr</sub>		-40 to 85	°C
Input rise time	dt/dv	·	0 to 10	ns/V
Input fall time	dt/dv		0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused control inputs must be tied to either  $V_{\text{CC}}$  or GND.



#### 11. Electrical Characteristics

# 11.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 85 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage (S)	$V_{IH}$		_	1.65 to 1.95	$0.8 \times V_{CC}$	_	_	V
				2.3 to 5.5	$0.7 \times V_{CC}$	_	_	
Low-level input voltage (S)	V <sub>IL</sub>		_	1.65 to 1.95	_	_	$0.2 \times V_{CC}$	
				2.3 to 5.5	_	_	$0.3 \times V_{CC}$	
Input leakage current	I <sub>IN</sub>		V <sub>IN</sub> = 0 to 5.5 V	1.65 to 5.5	_	_	±1.0	μА
Switch OFF-state leakage current	I <sub>SZ</sub>		B1, B2 = 0 to V <sub>CC</sub>	1.65 to 5.5	_	_	±10	
ON-resistance	R <sub>ON</sub>		V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 30 mA	4.5	_	4	7	Ω
		(Note 2)	V <sub>IS</sub> = 2.4 V, I <sub>IS</sub> = 30 mA	4.5	_	5	12	
			V <sub>IS</sub> = 4.5 V, I <sub>IS</sub> = 30 mA	4.5		6	10	
			V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 24 mA	3.0		5	9	
			$V_{IS}$ = 3.0 V, $I_{IS}$ = 24 mA	3.0		7	14	
			$V_{IS} = 0 \text{ V}, I_{IS} = 8 \text{ mA}$	2.3		6	12	
			$V_{IS}$ = 2.3 V, $I_{IS}$ = 8 mA	2.3		9	18	
			$V_{IS} = 0 \text{ V}, I_{IS} = 4 \text{ mA}$	1.65		8	20	
			V <sub>IS</sub> = 1.65 V, I <sub>IS</sub> = 4 mA	1.65		15	30	
Quiescent supply current	Icc		$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ A	5.5	_		10	μА
	$\Delta I_{CC}$		$V_{IN} = V_{CC} - 0.6 V$	5.5	_	_	50	μА

Note 1: All typical values are at  $T_a = 25$  °C.

# 11.2. AC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit					
3-state output enable time	t <sub>PZL</sub> /t <sub>PZH</sub>		Table 11.2.1	$5.0\pm0.5$	_	4	ns					
				$3.3\pm0.3$	-	6						
				$2.5 \pm 0.2$		8						
									$1.8 \pm 0.15$	_	16	
3-state output disable time	t <sub>PLZ</sub> /t <sub>PHZ</sub>		Table 11 2 1	$5.0\pm0.5$	-	4.5						
				$3.3 \pm 0.3$	-	7						
			$2.5 \pm 0.2$	_	9							
				1.8 ± 0.15		16						

# 11.3. Capacitive Characteristics (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance(S)	C <sub>IN</sub>		V <sub>IN</sub> = 0 V	5.0	4	pF
Switch terminal OFF-capacitance	C <sub>I/O</sub>		B Port,V <sub>I/O</sub> = 0 V	5.0	5	
Switch terminal ON-capacitance	C <sub>I/O</sub>		A Port,V <sub>I/O</sub> = 0 V	5.0	15	
			B Port,V <sub>I/O</sub> = 0 V	5.0	15	

Note: Parameter guaranteed by design.

Note 2: Measured by the voltage drop between A and B pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two (A or B) pins.



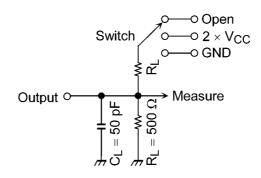


Fig. 11.2.1 AC Test Circuit

Table 11.2.1 Parameter for AC Test Circuit

Parameter	Switch
t <sub>PLZ</sub> , t <sub>PZL</sub>	$2\times V_{CC}$
t <sub>PHZ</sub> , t <sub>PZH</sub>	GND

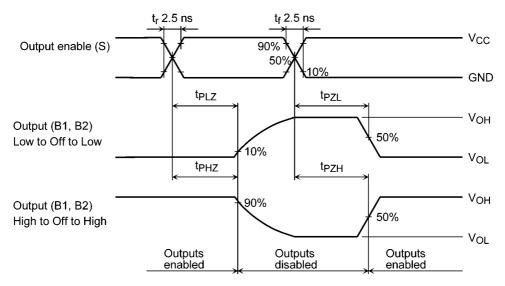


Fig. 11.2.2 AC Waveform t<sub>PLZ</sub>, t<sub>PHZ</sub>, t<sub>PZL</sub>, t<sub>PZH</sub>



### 12. Rise and Fall Time (t<sub>r</sub>/t<sub>f</sub>)

The  $t_{r(out)}$  and  $t_{f(out)}$  values of the output signals are affected by the CR time constant of the input, which consists of the switch terminal capacitance ( $C_{I/O}$ ) and the on-resistance ( $R_{ON}$ ) of the input.

In practice, the  $t_{r(out)}$  and  $t_{f(out)}$  values are also affected by the circuit's capacitance and resistance components other than the capacitance of TC7SB3157DL6X

The  $t_r/t_{f(out)}$  values can be approximated as follows.

(Figure 12.1, Table 12.1 shows the test circuit.)

$$t_r/t_{f(out)} \; (approx) = - \; (C_{I/O} + C_L) \; \; \cdot \; \; (R_{DRIVE} + R_{ON}) \; \; \cdot \; \; ln \; (((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; / \; (V_{OH} - V_{OL})) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ((V_{OH} - V_{OL}) - V_M) \; . \; \; ln \; ($$

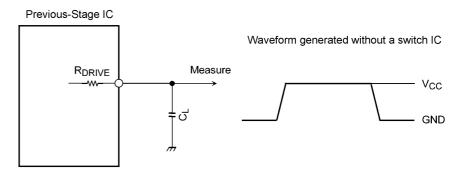
Where,  $R_{\mbox{\scriptsize DRIVE}}$  is the output impedance of the previous-stage circuit.

#### Calculation example:

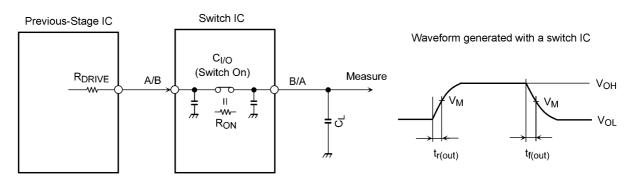
$$t_{r(out)}$$
 (approx) =  $\cdot$  (15 + 15) E  $\cdot$  12  $\cdot$  (120 + 4)  $\cdot$  ln (((4.5  $\cdot$  0)  $\cdot$  2.25) / (4.5  $\cdot$  0)) =  $\approx$ 2.6 ns

#### Calculation conditions:

 $V_{CC}$  = 4.5 V,  $C_L$  = 15 pF,  $R_{DRIVE}$  = 120  $\Omega$  (output impedance of the previous IC),  $V_M$  = 2.25 V ( $V_{CC}$ /2) Output of the previous IC = digital (i.e., high-level voltage =  $V_{CC}$ , low-level voltage = GND)



R<sub>DRIVE</sub> = output impedance of the previous-stage IC



R<sub>DRIVE</sub> = output impedance of the previous-stage IC

Fig. 12.1 Calculation Circuit

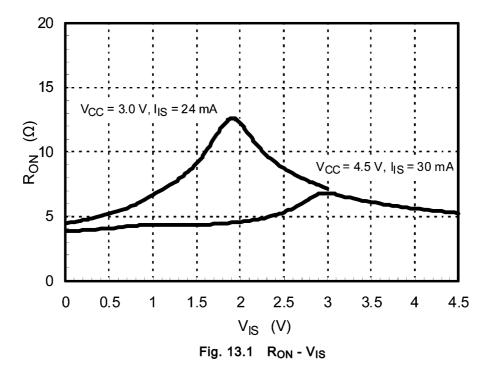
Table 12.1 Calculation Circuit

Characteristics	$V_{CC}$ = 5.0 $\pm$ 0.5 $V$	$V_{CC}$ = 3.3 $\pm$ 0.3 V	$V_{CC}$ = 2.5 $\pm$ 0.2 V	V <sub>CC</sub> = 1.8 ± 0.15 V
$V_{M}$	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2

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# 13. Characteristics Curves (Note)

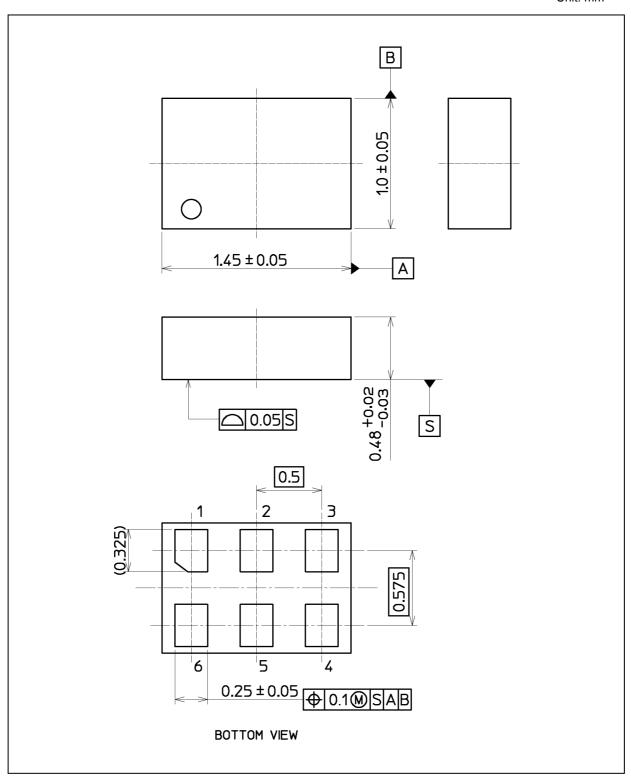


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### **Package Dimensions**

Unit: mm



Weight: 0.002 g (typ.)

Package Name(s)
Nickname: MP6D



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